

General Description

The SJM60N120 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

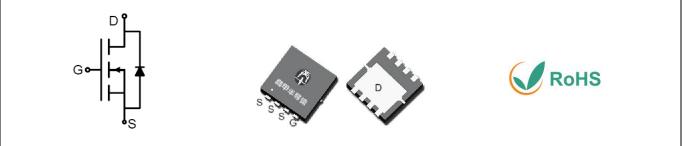
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	60	V
R _{DS(ON)_TYP}	12.8	mΩ
ID	33	А
Q _G	45.4	nC



Schematic Diagram

PDFN3X3-8L top&bottom view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM60N120	SJM60N120	PDFN3X3-8L	Таре	١	١	5000 Pcs

Table 1. Absolute Maximum Ratings ($T_c=25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	60	V
V _{GS}	Gate-Source Voltage (V _{DS} =0V)	±20	V
1	Drain Current-Continuous(Tc=25℃)	33	А
lD	Drain Current-Continuous(T _C =100 ℃)	21	А
DM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	132	А
P	Maximum Power Dissipation($T_C=25^{\circ}C$)	41	W
Po	Maximum Power Dissipation(Tc=100°C)	16	W
E _{AS}	Avalanche energy (Note 2)	110	mJ
TJ, TSTG	Operating Junction and Storage Temperature Range	-55 To 150	Ĉ

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R _θ JC	Thermal Resistance, Junction-to-Case		3.07	°C/W



Table 3. Electrical Characteristics (T_J=25 $^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250µA	60			V
	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V TJ=25℃			1	μA
IDSS		V _{DS} =60V, V _{GS} =0V T _J =125℃			100	μA
lgss	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250µA	1		2	V
g fs	Forward Transconductance	V _{DS} =10V, I _D =20A		21		S
Rds(on)	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A T _J =25℃		12.8	16.6	mΩ
Rds(on)	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =15A TJ=25℃		15.5	20.6	mΩ
Dynamic Chara	acteristics					
Ciss	Input Capacitance			2098		pF
Coss	Output Capacitance	V _{DS} =30V,V _{GS} =0V, f=1.0MHz		103		pF
Crss	Reverse Transfer Capacitance			93		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		1.5		Ω
Switching Para	meters		•			
t _{d(on)}	Turn-on Delay Time			10		nS
tr	Turn-on Rise Time	V _{GS} =10V, V _{DS} =30V,		7.6		nS
$t_{d(\text{off})}$	Turn-Off Delay Time	$R_L=3\Omega, R_{GEN}=6\Omega$		56.4		nS
t _f	Turn-Off Fall Time			13.2		nS
Qg	Total Gate Charge			45.4		nC
Q _{gs}	Gate-Source Charge	V _{GS} =10V, V _{DS} =30V, I _D =10A		9.6		nC
Q_gd	Gate-Drain Charge			6.4		nC
Source-Drain D	Diode Characteristics					
I _{SD}	Source-Drain Current (Body Diode)				33	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =20A			1.2	V
t _{rr}	Reverse Recovery Time	l⊧=10A, dl/dt=100A/μs		20		ns
Qrr	Reverse Recovery Charge	l⊧=10A, dl/dt=100A/μs		19.8		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=40V$, $V_G=10V$, $Rg=25\Omega$, L=0.5mH.

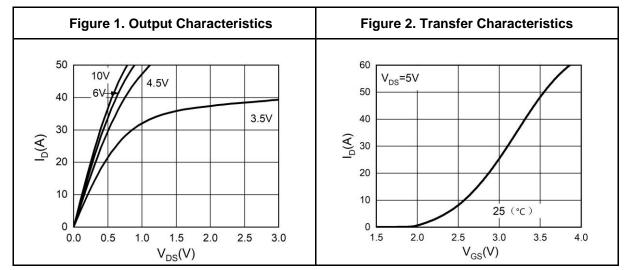
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

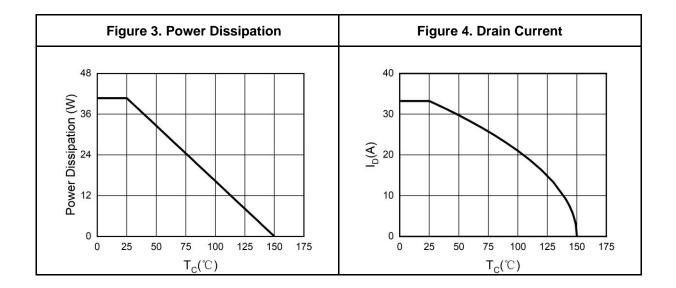


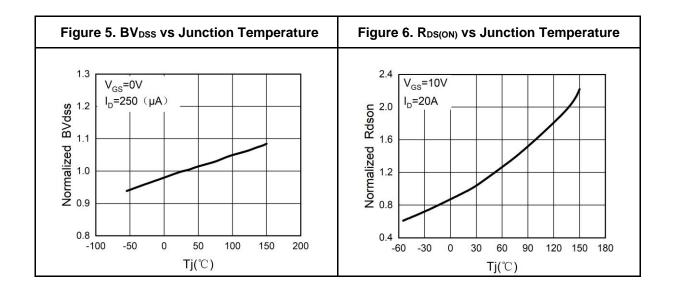
SJM60N120

60V N-Channel Trench Power MOSFET

Typical Electrical And Thermal Characteristics (Curves)



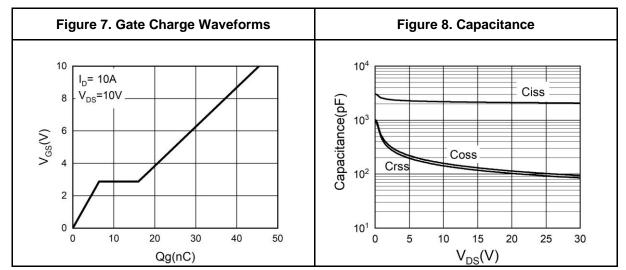


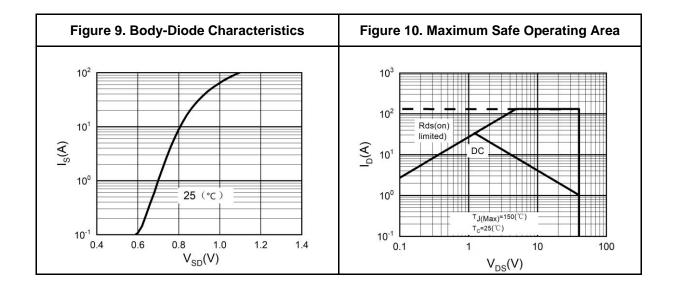




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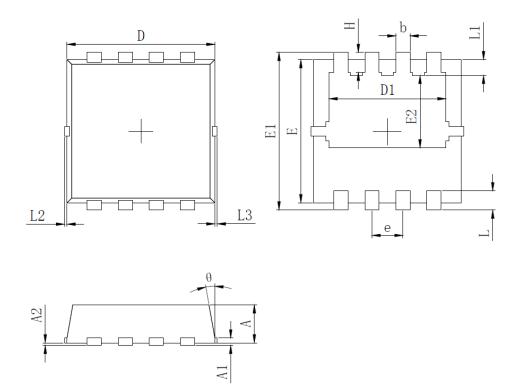
Typical Electrical And Thermal Characteristics (Curves)







PDFN3X3-8L Package Information



SYMBOL		MILLIMETER				
SIMDUL	MIN	Typ.	MAX			
А	0.700	0.800	0.900			
A1		0.152 REF.				
A2		0 [~] 0. 05				
D	3.000	3.100	3. 200			
D1	2.300	2.450	2.600			
Е	2.900	3.000	3.100			
E1	3.150	3. 300	3.450			
E2	1.320	1.520	1.720			
b	0.200	0.300	0.400			
е	0.550	0.650	0.750			
L	0.300	0.400	0.500			
L1	0.180	0.330	0.480			
L2	0~0.100					
L3	0 [~] 0.100					
Н	0.315	0.415	0.515			
θ	8°	10°	12°			



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